# Panel Measuring Table

### **Coating Thickness Measurement and Quality Control**

Fast and precise measuring of PCB copper thickness for monitoring of etching and plating processes. The measuring report gives information about the minimum, maximum and average value as well as the standard deviations.



## 🔀 PANEL MEASURING TABLE



#### Details

The panel measuring table offers a quick determination of the etching distribution after differential etching processes or the plating build-up of copper surfaces. The measurements are carried out fully automatically by a resistive sensor after entering the input parameters.

Subsequently, the measuring points are evaluated by a PC and converted into a 3D diagram, statistics tool included.

### **Technical Data**

- Dimensions: 1200 x 1120 x 1210 mm (L x W x H)
- Weight: 200 kg
- Maximum panel size: 650 x 650 mm
- Measuring range: copper thicknesses 1 μm - 120 μm
- Measuring tolerances:

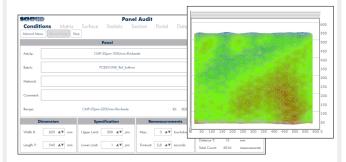
 $\begin{array}{l} \underline{0.1\ \mu\text{m} \cdot 10\ \mu\text{m}} \\ \text{Cu layer } 0.1\ \mu\text{m} \cdot 5\ \mu\text{m}: \pm 0.075\ \mu\text{m} \\ \text{Cu layer } 5\ \mu\text{m} \cdot 10\ \mu\text{m}: \pm < 1,5\ \%\ 5 \\ \underline{\mu\text{m} \cdot 120\ \mu\text{m}} \\ \text{Cu layer } 5\ \mu\text{m} \cdot 50\ \mu\text{m}: \pm 0.5\ \mu\text{m}\ \text{Cu layer } 50\ \mu\text{m} \cdot 80\ \mu\text{m}: \pm < 1\ \% \\ \text{Cu layer } 80\ \mu\text{m} \cdot 120\ \mu\text{m}: \pm < 2\ \% \end{array}$ 

#### **Parameter Input:**

- Panel dimensions in X and Y direction
- Measuring point distance from panel edge
- Number of measuring points in X and Y direction
- Graphical feedback if out of specification
- Measuring specification
- Individual selection of measuring points

#### Data Output by Excel file:

- Maximum and minimum value
- Average value
- Standard deviation
- 3D and line diagrams with measuring report
- CP and CPK analysis
- All values stored in a SQL server (database)



#### Statistical and 3D view of a measured panel

#### Advantages

- Precise and repeatable: fully automated measurement avoids manual handling and operation error
- Fast: 100 measuring points in 3.5 min
- Flexible: accommodates variable panel formats
- Quality control of etching and plating processes
- Process drifts are easy to spot and to correct
- Reduction of yield loss by early detection

